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## **CLAIMS**

- 1. A process for fabricating a thin-film magnetic head having an air bearing surface (ABS), the method comprising the unordered steps of:
  - (a) polishing the surface of a first side of a monolithic substrate wafer;
- (b) forming on the surface of the first side of the monolithic substrate wafer a first array of magnetic read head structures and magnetic write head structures each having a head gap;
  - (c) polishing the surface of the other side of the monolithic substrate wafer;
- (d) forming on the surface of the other side of the monolithic substrate wafer a second array of magnetic read head structures and magnetic write head structures disposed such that a plurality of the magnetic read head gaps on one of the monolithic substrate surfaces are each aligned to form a read/write track-pair with a corresponding one of the magnetic write head gaps on the other monolithic substrate surface;
- (e) cutting the monolithic substrate to expose the head gaps of a plurality of read/write track-pairs; and
  - (f) lapping the ABS to refine the depth of the exposed head gaps.
  - 2. The method of claim 1 wherein the first and second arrays comprise:
    a plurality of magnetic read and write head structures disposed such that each
    read head structure is covered by a collocated write head structure in a piggy-back
    configuration.
  - 3. The method of claim 2 wherein each of the magnetic read heads includes a magnetoresistive (MR) sensor element.
    - 4. The method of claim 1 further comprising the step of:
- (h) cutting the monolithic substrate to separate therefrom a thin-film magnetic head having a single read/write track-pair.

- 5. The method of claim 4 wherein each of the magnetic read heads includes a magnetoresistive (MR) sensor element.
- 6. The method of claim 1 wherein the first array comprises a plurality of magnetic read head structures adjoining one another and the second array comprises a plurality of magnetic write head structures adjoining one another.
  - 7. The method of claim 1 wherein each of the magnetic read heads includes a magnetoresistive (MR) sensor element.
  - 8. A thin-film magnetic tape head having an air bearing surface (ABS), the head comprising:
    - a monolithic substrate layer having two sides;
  - a plurality of thin-film read head structures and thin-film write head structures disposed on a first side of the monolithic substrate layer, each having a head gap disposed at the ABS; and
    - a plurality of thin-film read head structures and thin-film write head structures disposed on a second side of the monolithic substrate layer, each having a head gap disposed at the ABS and aligned such that a plurality of read head gaps on one of the monolithic substrate surfaces are each aligned to form a read/write track-pair with a corresponding one of write head gaps on the other monolithic substrate surface.
    - 9. The magnetic head of claim 8 wherein the pluralities of thin-film read and write structures are such that each read head structure is covered by a collocated write head structure in a piggy-back configuration.
    - 10. The method of claim 9 wherein each of the read heads includes a magnetoresistive (MR) sensor element.

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- 11. The magnetic head of claim 8 wherein the pluralities of thin-film read and write structures are disposed in an alternating pattern such that each non-edge read head structure adjoins at least two write head structures.
- 5 12. The method of claim 11 wherein each of the read heads includes a magnetoresistive (MR) sensor element.
  - 13. The method of claim 8 wherein each of the read head gaps includes a magnetoresistive (MR) sensor element.

- 14. A magnetic tape drive comprising:
- a magnetic recording medium having a recording surface;
- a motor for moving the magnetic recording medium;
- a thin-film magnetic tape head having an air bearing surface (ABS) and including:
  - a monolithic substrate layer having two sides;
  - a plurality of thin-film read head structures and thin-film write head structures disposed on a first side of the monolithic substrate layer, each having a head gap disposed at the ABS; and

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a plurality of thin-film read head structures and thin-film write head structures disposed on a second side of the monolithic substrate layer, each having a head gap disposed at the ABS and aligned such that a plurality of the read head gaps on one of the monolithic substrate surfaces are each aligned to form a read/write track-pair with a corresponding one of the write head gaps on the other monolithic substrate surface; and

- a head-mount assembly for supporting the magnetic tape head with respect to the magnetic recording medium.
- 15. The magnetic tape drive of claim 14 wherein the pluralities of thin-film read and write structures are such that each read head structure is covered by a collocated

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write head structure in a piggy-back configuration.

- 16. The method of claim 15 wherein each of the read heads includes a magnetoresistive (MR) sensor element.
- 17. The magnetic head of claim 14 wherein the pluralities of thin-film read and write structures are disposed in an alternating pattern such that each non-edge read head structure adjoins at least two write head structures.
- 18. The method of claim 17 wherein each of the read heads includes a magnetoresistive (MR) sensor element.
  - 19. The method of claim 14 wherein each of the read heads includes a magnetoresistive (MR) sensor element.
  - 20. A process for fabricating a thin-film magnetic head having an air bearing surface (ABS), the method comprising the unordered steps of:
    - (a) polishing the surface of a front side of a monolithic substrate wafer;
    - (b) forming on the surface of the front side of the monolithic substrate wafer an array of magnetic read head structures and magnetic write head structures each having a head gap;
    - (c) sectioning the monolithic substrate wafer to form a plurality of wafer subsections each having a back surface;
    - (d) fixing the back surfaces of a pair of the wafer subsections to one another disposed such that a plurality of the magnetic read head gaps on the front surface of one of the wafer subsections are each aligned to form a read/write track-pair with a corresponding one of the magnetic write head gaps on the front surface of the other wafer subsection;
    - (e) cutting the fixed pair of wafer subsections to expose the head gaps of a plurality of read/write track-pairs; and
      - (f) lapping the ABS to refine the depth of the exposed head gaps.

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21. The method of claim 20 wherein the first and second arrays comprise:

- a plurality of magnetic read and write head structures disposed such that each read head structure is covered by a collocated write head structure in a piggy-back configuration.
- 22. The method of claim 21 wherein each of the magnetic read heads includes a magnetoresistive (MR) sensor element.
- 23. The method of claim 20 further comprising the step of:
  - (h) cutting the fixed pair of wafer subsections to separate therefrom a thinfilm magnetic head having a single read/write track-pair.
- 24. The method of claim 23 wherein each of the magnetic read heads includes
  15 a magnetoresistive (MR) sensor element.
  - 25. The method of claim 20 wherein the array comprises a plurality of magnetic read head structures adjoining one another.
- 26. The method of claim 20 wherein each of the magnetic read heads includes a magnetoresistive (MR) sensor element.
  - 27. A thin-film magnetic tape head having an air bearing surface (ABS), the head comprising:
- a pair of wafer subsections each having front and back sides wherein the two back surfaces are fixed to one another;
  - a plurality of thin-film read head structures and thin-film write head structures disposed on the front surface of one of the wafer subsections, each having a head gap disposed at the ABS; and

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a plurality of thin-film read head structures and thin-film write head structures disposed on the front surface of the other wafer subsection, each having a head gap disposed at the ABS and aligned such that a plurality of read head gaps on one of the wafer subsections are each aligned to form a read/write track-pair with a corresponding one of write head gaps on the other wafer subsection.

- 28. The magnetic head of claim 27 wherein the pluralities of thin-film read and write structures are such that each read head structure is covered by a collocated write head structure in a piggy-back configuration.
- 29. The method of claim 28 wherein each of the read heads includes a magnetoresistive (MR) sensor element.
- 15 **30.** The magnetic head of claim 27 wherein the pluralities of thin-film read and write structures are disposed in an alternating pattern such that each non-edge read head structure adjoins at least two write head structures.
- 31. The method of claim 30 wherein each of the read heads includes a magnetoresistive (MR) sensor element.
  - 32. The method of claim 27 wherein each of the read head gaps includes a magnetoresistive (MR) sensor element.
    - 33. A magnetic tape drive comprising:
      - a magnetic recording medium having a recording surface;
      - a motor for moving the magnetic recording medium;
  - a thin-film magnetic tape head having an air bearing surface (ABS) and including:
  - a pair of wafer subsections each having front and back sides wherein the

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two back surfaces are fixed to one another;

a plurality of thin-film read head structures and thin-film write head structures disposed on the front surface of one of the wafer subsections, each having a head gap disposed at the ABS; and

a plurality of thin-film read head structures and thin-film write head structures disposed on the front surface of the other wafer subsection, each having a head gap disposed at the ABS and aligned such that a plurality of read head gaps on one of the wafer subsections are each aligned to form a read/write track-pair with a corresponding one of write head gaps on the other wafer subsection; and

a head-mount assembly for supporting the magnetic tape head with respect to the magnetic recording medium.

- The magnetic tape drive of claim 33 wherein the pluralities of thin-film read and write structures are such that each read head structure is covered by a collocated write head structure in a piggy-back configuration.
- 35. The method of claim 34 wherein each of the read heads includes a magnetoresistive (MR) sensor element.
  - 36. The magnetic head of claim 33 wherein the pluralities of thin-film read and write structures are disposed in an alternating pattern such that each non-edge read head structure adjoins at least two write head structures.

- 37. The method of claim 36 wherein each of the read heads includes a magnetoresistive (MR) sensor element.
- 38. The method of claim 33 wherein each of the read heads includes a magnetoresistive (MR) sensor element.